



Attv. Dkt. No. AMAT/6089.Y2/PPC/ECP/RKK

**Application of:**

# Kholodenko

**Serial No.: 10/061,126**

Confirmation No.: 2260

Filed: January 30, 2002

For: Method and Apparatus for Encapsulation of an Edge of a Substrate During an Electro-Chemical Deposition Process

Group Art Unit: 1742

**Examiner:** Lois L. Zheng

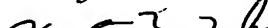
**MAIL STOP AMENDMENT**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

Dear Sir:

CERTIFICATE OF MAILING  
37 CFR 1.8

I hereby certify that this correspondence is being deposited on  
2/8/05, with the United States Postal Service as  
First Class Mail in an envelope addressed to: Mail Stop  
Amendment, Commissioner for Patents, Washington, D.C.  
20231.

2/8/05  
Date

  
Signature

**RESPONSE TO OFFICE ACTION DATED OCTOBER 13, 2004**

In response to the Office Action dated October 13, 2004, having a shortened statutory period for response extended one month to expire on February 13, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/6089.Y2/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 7 of this paper.